

POSITIONING

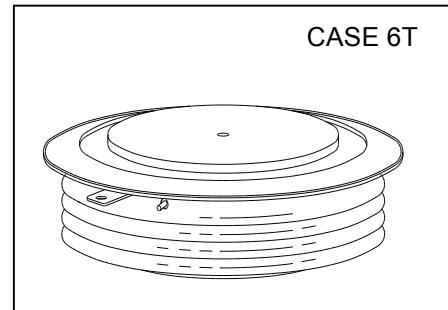
PSTC771 - Power Thyristor

 2200 - 2500 V_{DRM}; 2500 A avg

HIGH POWER THYRISTOR FOR INVERTER APPLICATIONS

Features:

- . All Diffused Structure
- . Involute Amplifying Gate Configuration
- . Blocking capability up to 2500 volts
- . Guaranteed Maximum Turn-Off Time
- . High dV/dt Capability
- . Pressure Assembled Device



ELECTRICAL CHARACTERISTICS AND RATINGS

Blocking - Off State

Device Type	V _{RRM} (1)	V _{DRM} (1)	V _{RSM} (1)
PSTC771LB	2200	2200	2300
PSTC771LE	2500	2500	2600

 V_{RRM} = Repetitive peak reverse voltage

 V_{DRM} = Repetitive peak off state voltage

 V_{RSM} = Non repetitive peak reverse voltage (2)

Repetitive peak reverse leakage and off state leakage	I _{RRM} / I _{DRM}	20 mA 100 mA (3)
Critical rate of voltage rise	dV/dt (4)	500 V/μsec

Conducting - on state

Notes:

All ratings are specified for T_j=25 °C unless otherwise stated.

(1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range -40 to +125 °C.

(2) 10 msec. max. pulse width

(3) Maximum value for T_j = 125 °C.

(4) Minimum value for linear and exponential waveshape to 80% rated V_{DRM}. Gate open. T_j = 125 °C.

(5) Non-repetitive value.

(6) The value of di/dt is established in accordance with EIA/NIMA Standard RS-397, Section 5-2-2-6. The value defined would be in addition to that obtained from a snubber circuit, comprising a 0.2 μF capacitor and 20 ohms resistance in parallel with the thristor under test.

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average value of on-state current	I _{T(AV)}		2500		A	Sinewave, 180° conduction, T _c =55°C
RMS value of on-state current	I _{TRMS}		3925		A	Nominal value
Peak one cPSTCle surge (non repetitive) current	I _{TSM}		40000 38000		A A	8.3 msec (60Hz), sinusoidal wave- shape, 180° conduction, T _j = 125 °C 10.0 msec (50Hz), sinusoidal wave- shape, 180° conduction, T _j = 125 °C
I square t	I ² t		6.8x10 ⁶		A ² s	8.3 msec
Latching current	I _L		1000		mA	V _D = 24 V; R _L = 12 ohms
Holding current	I _H		500		mA	V _D = 24 V; I = 2.5 A
Peak on-state voltage	V _{TM}		2.25		V	I _{TM} = 4000 A; T _j = 125 °C
Critical rate of rise of on-state current (5, 6)	di/dt		800		A/μs	Switching from V _{DRM} ≤ 1000 V, non-repetitive
Critical rate of rise of on-state current (6)	di/dt		400		A/μs	Switching from V _{DRM} ≤ 1000 V

Gating

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Peak gate power dissipation	P _{GM}		200		W	t _p = 40 us
Average gate power dissipation	P _{G(AV)}		5		W	
Peak gate current	I _{GM}		20		A	
Gate current required to trigger all units	I _{GT}		300 200 125		mA	V _D = 6 V; R _L = 3 ohms; T _j = -40 °C V _D = 6 V; R _L = 3 ohms; T _j = +25 °C V _D = 6 V; R _L = 3 ohms; T _j = +125 °C
Gate voltage required to trigger all units	V _{GT}	0.30	5 4		V	V _D = 6 V; R _L = 3 ohms; T _j = -40 °C V _D = 6 V; R _L = 3 ohms; T _j = 0-125 °C V _D = Rated V _{DRM} ; R _L = 1000 ohms; T _j = + 125 °C
Peak negative voltage	V _{GRM}		20		V	

Dynamic

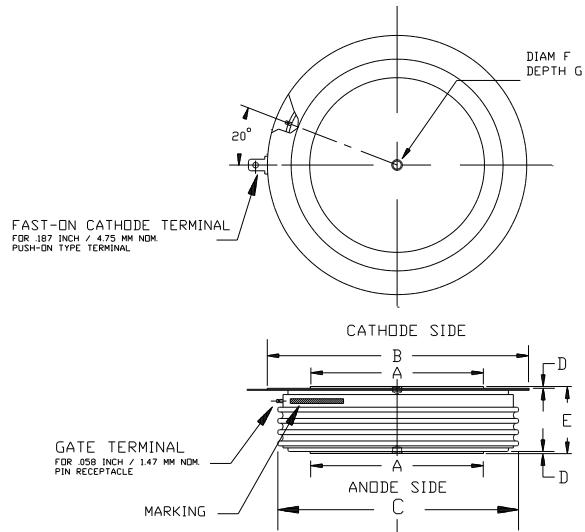
Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Delay time	t _d		2.0		μs	I _{TM} = 50 A; V _D = 67% V _{DRM} Gate pulse: V _G = 30 V; R _G = 10 ohms; t _r = 0.1 μs; t _p = 20 μs
Turn-off time (with V _R = -5 V)	t _q		80		μs	I _{TM} > 2000 A; di/dt = 25 A/μs; V _R ≥ -5 V; Re-applied dV/dt = 400 V/μs linear to 67% V _{DRM} ; T _j = 125 °C; Duty cPSTCle ≥ 0.01%
Reverse recovery current	I _{rr}		450		A	I _{TM} > 2000 A; di/dt = 50 A/μs; V _R ≥ -50 V; T _j = 125 °C

THERMAL AND MECHANICAL CHARACTERISTICS AND RATINGS

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	T _j	-40	+125		°C	
Storage temperature	T _{stg}	-40	+150		°C	
Thermal resistance - junction to case	R _{θ(j-c)}		0.012		°C/W	Double sided cooled
Thermal resistamce - case to sink	R _{θ(c-s)}		0.001		°C/W	Double sided cooled *
Mounting force	P	8000 35.5	10000 44.4		lb. kN	
Weight	W			3.5 1.60	lb. Kg.	

* Mounting surfaces smooth, flat and greased

Note : for case outline and dimensions, see case outline drawing in page 3 of this Technical Data



**CASE 5
NOMINAL OUTLINE DIMENSIONS**

DIMENSIONS	INCH	MM
DIAM. A	2.88	73.2
DIAM. B	4.36	110.7
DIAM. C	3.95	100.3
D	.030	.76
E	1.400 / 1.440	35.56 / 36.58
F	.140	3.56
G	.080	2.03

STRIKE DISTANCE = 1.04 inch / 26.4 mm MIN.
CREEPAGE DISTANCE = 1.64 inch / 41.6 mm MIN.

Add:Room303 Weiheng Building No.20 B Area Lanyuan Yangzhou Jiangsu P.R.C Zip:225000
 Contact Person:John Chang Tel:+86-514-7360558 Fax:+86-514-7782297;7367519
 E-mail:pst@pst888.com;positioning@china.com